



## Electrical and Optical Characteristics (Ta = 25°C)

Product Name	Typ. Emission Wavelength				Luminous Intensity I <sub>V</sub>			Forward Voltage V <sub>F</sub>			Reverse Current I <sub>R</sub>	
	λ <sub>d</sub>	λ <sub>P</sub>	Δλ	I <sub>F</sub>	Min	Typ.	I <sub>F</sub>	Typ.	Max	I <sub>F</sub>	Max	V <sub>R</sub>
TLRMH16TP(F)	626	(636)	13	20	476	1500	20	1.9	2.4	20	50	4
TLSH16TP(F)	613	(623)	13	20	850	1900	20	2.0	2.4	20	50	4
TLOH16TP(F)	605	(612)	13	20	850	2300	20	2.0	2.4	20	50	4
TLYH16TP(F)	587	(590)	13	20	850	2200	20	2.0	2.4	20	50	4
Unit	nm			mA	mcd		mA	V	mA	μA	V	

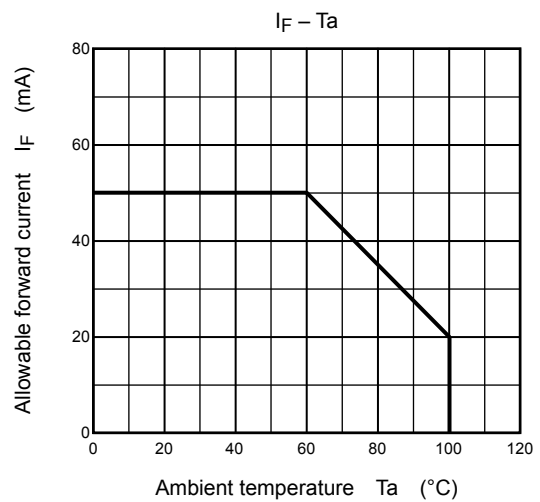
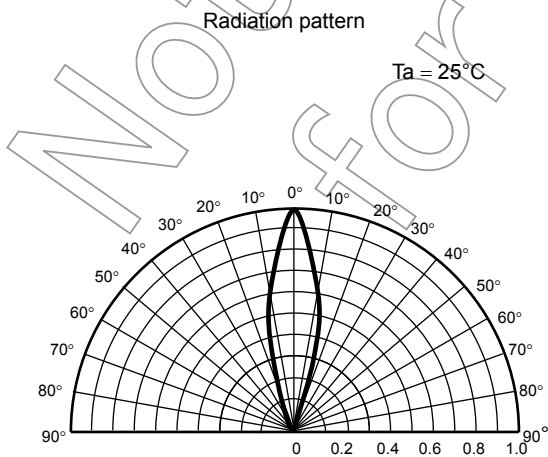
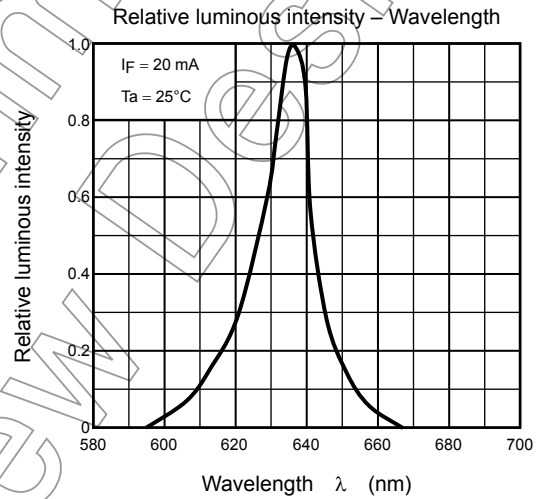
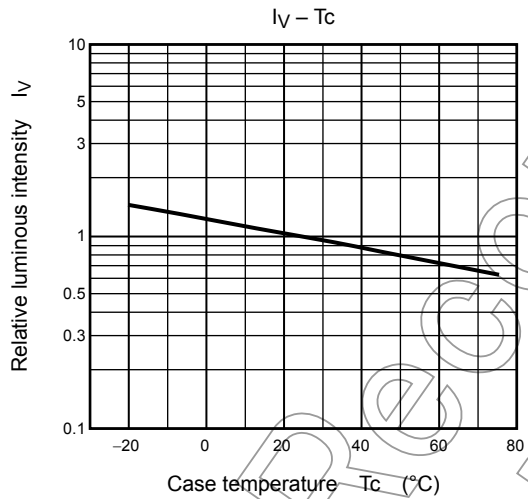
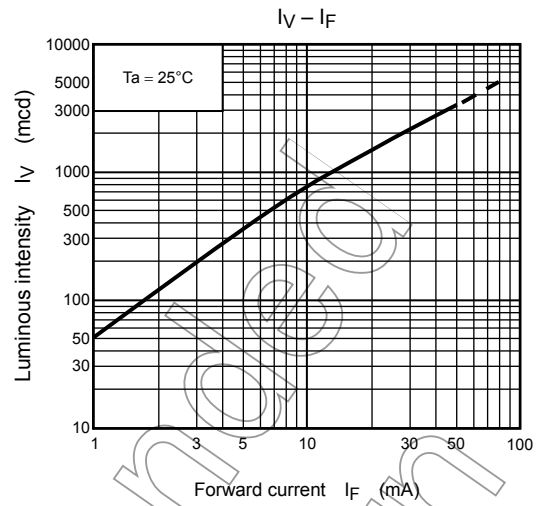
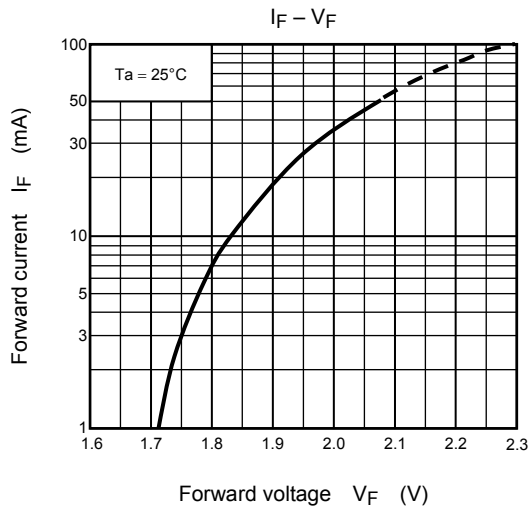
## Precautions

Please be careful of the following:

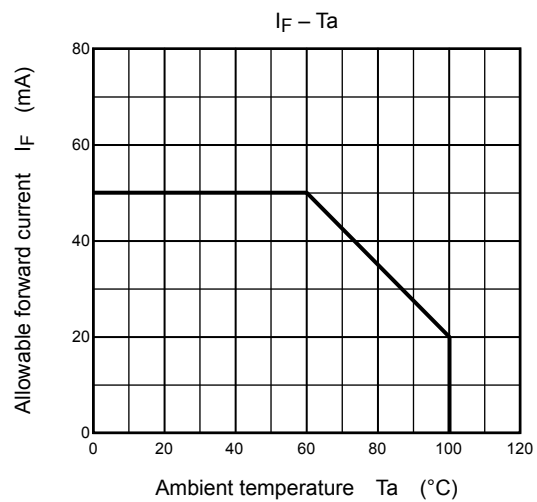
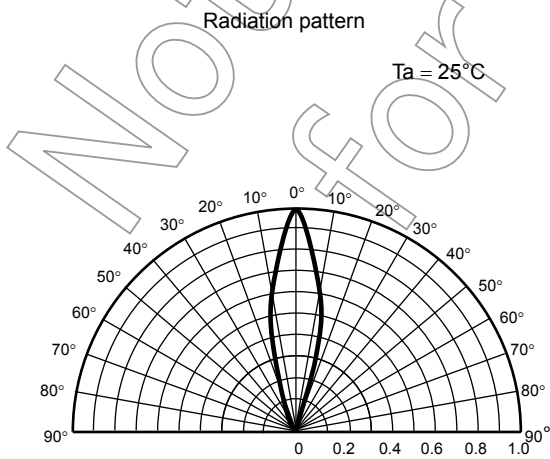
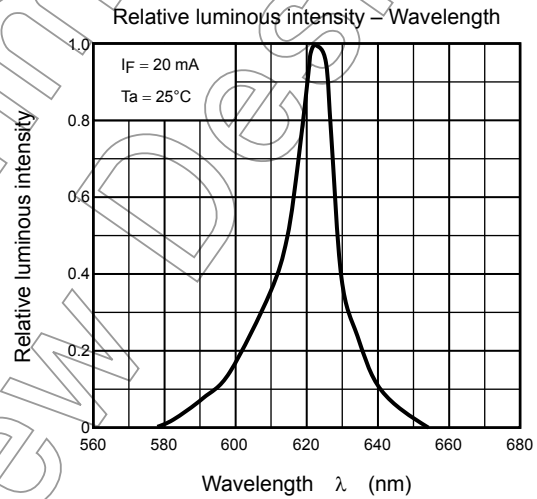
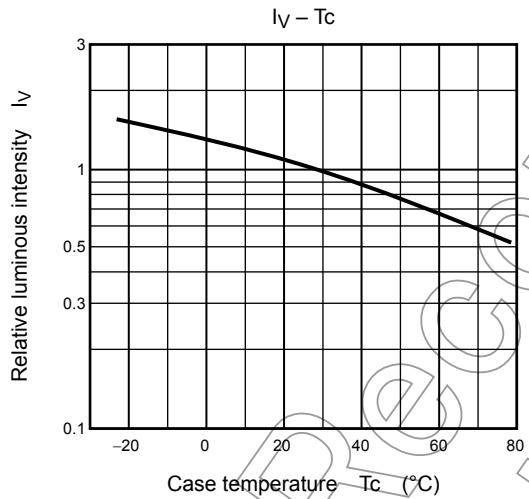
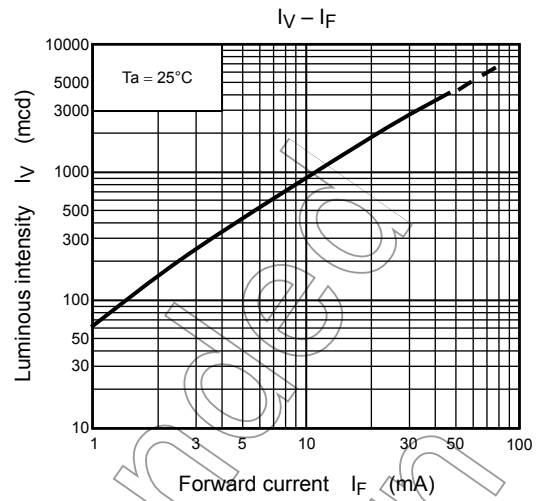
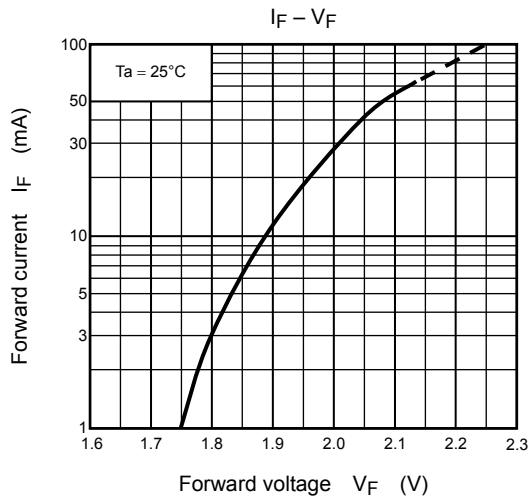
- Soldering temperature: 260°C max, soldering time: 3 s max  
(soldering portion of lead: up to 1.6 mm from the body of the device)
- If the lead is formed, the lead should be formed up to 1.6 mm from the body of the device without forming stress to the resin. Soldering should be performed after lead forming.
- This visible LED lamp also emits some IR light.  
If a photodetector is located near the LED lamp, please ensure that it will not be affected by this IR light.

Not Recommended for New Design

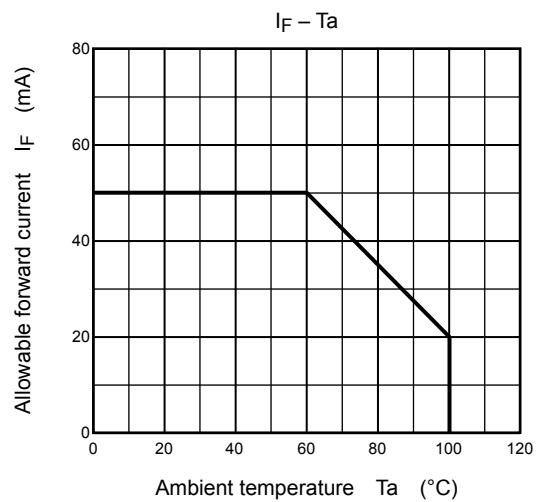
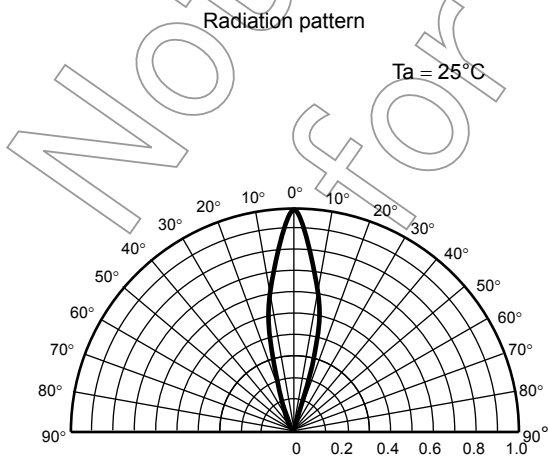
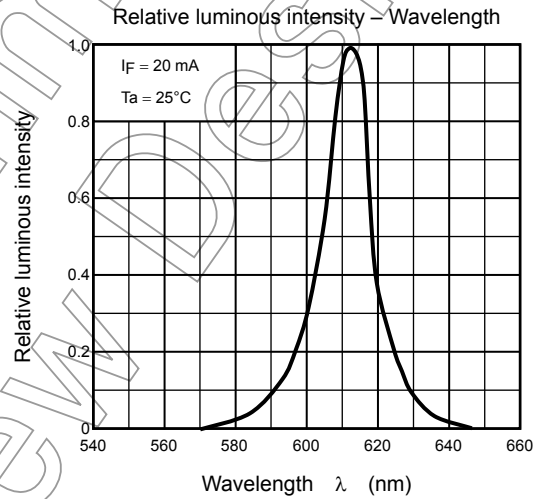
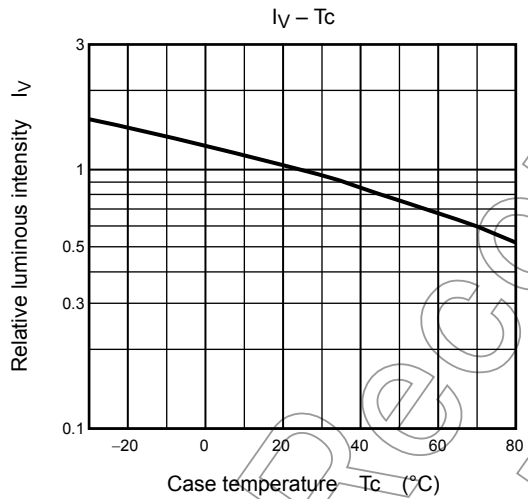
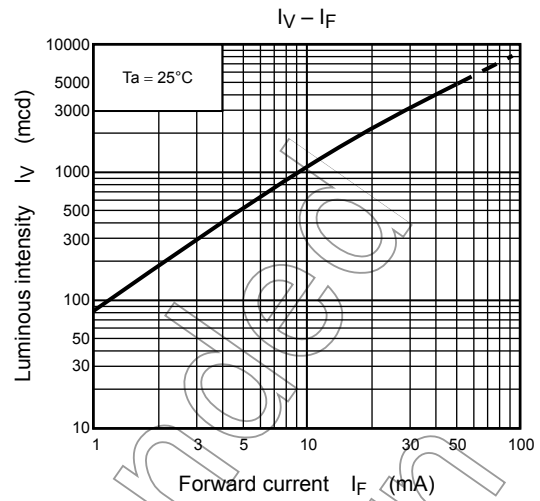
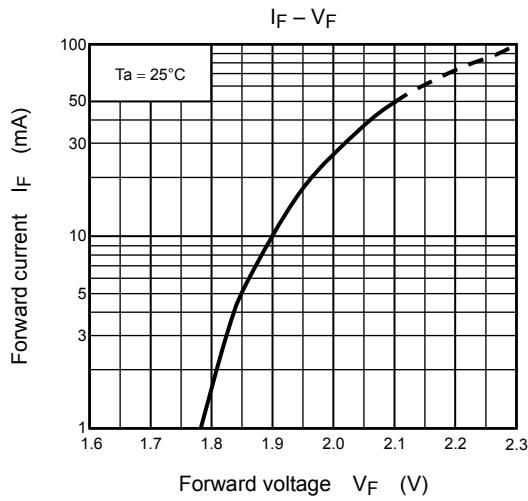
## TLRMH16TP(F)



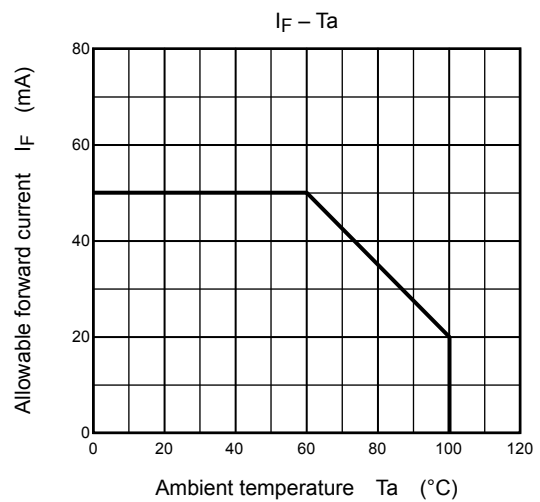
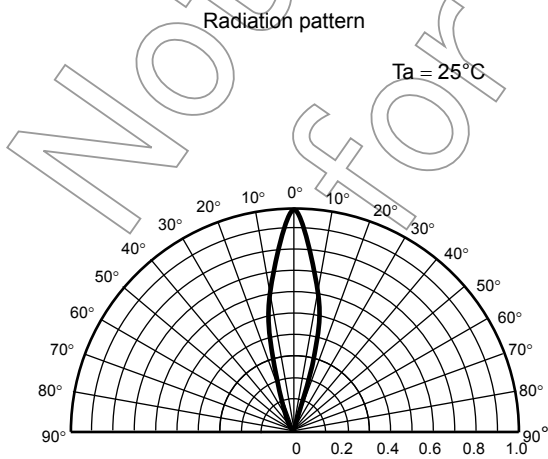
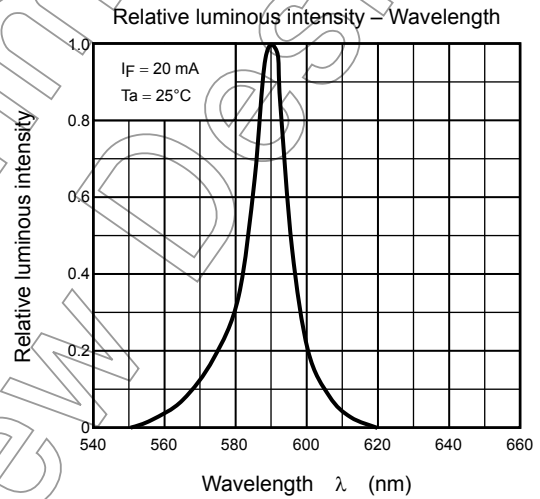
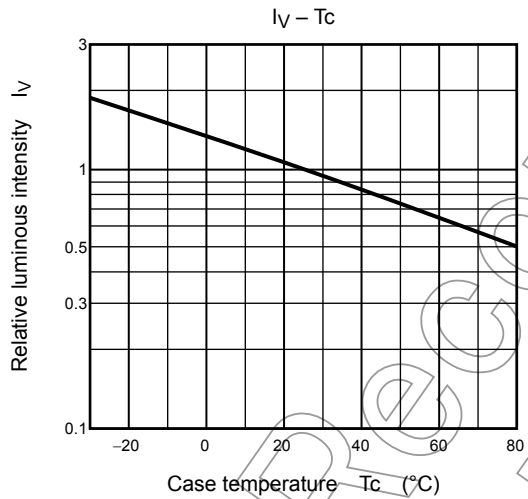
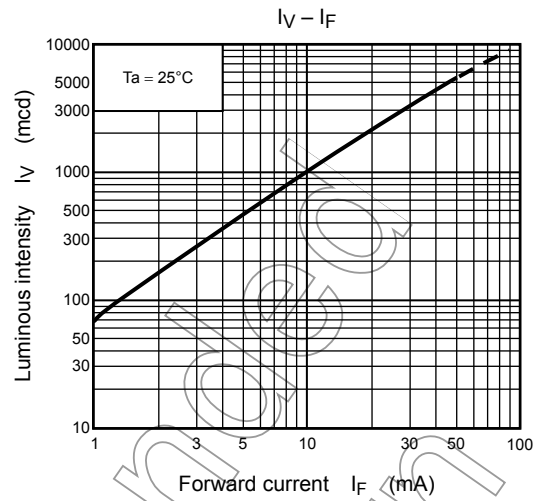
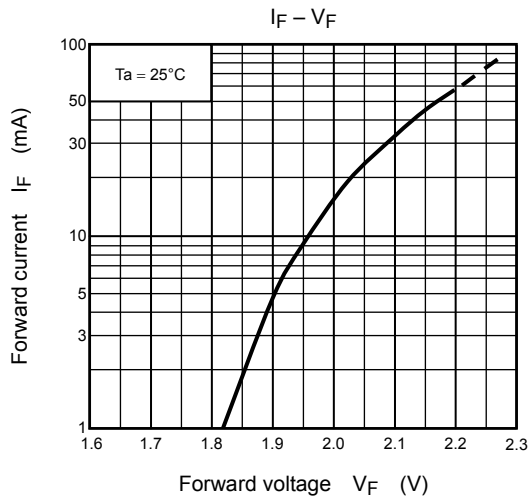
## TLSH16TP(F)



## TLOH16TP(F)



## TLYH16TP(F)



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